

Customer : **3LDG0**

## SPECIFICATION FOR APPROVAL

|              |                                                                                     |                                                                                      |                                                                                       |
|--------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Customer P/N | 0360211007F0                                                                        |                                                                                      |                                                                                       |
| Description  |                                                                                     |                                                                                      |                                                                                       |
| Drawing No.  |                                                                                     |                                                                                      |                                                                                       |
| 3L P/N       | SMTDRH105RQ-100M-CH                                                                 |                                                                                      |                                                                                       |
| Date         | 2021/11/25                                                                          | Rev.                                                                                 | XA                                                                                    |
| Customer     | Approved For Customer                                                               |                                                                                      |                                                                                       |
|              |                                                                                     |                                                                                      |                                                                                       |
| Seller       | Drawn                                                                               | Checked                                                                              | Approved                                                                              |
|              |  |  |  |

Please Return After Approving



**3L ELECTRONIC  
CORPORATION**

Headquarters: 3L ELECTRONIC (ZHONG SHAN) CORP.

URL: <http://www.3lcoil.com>

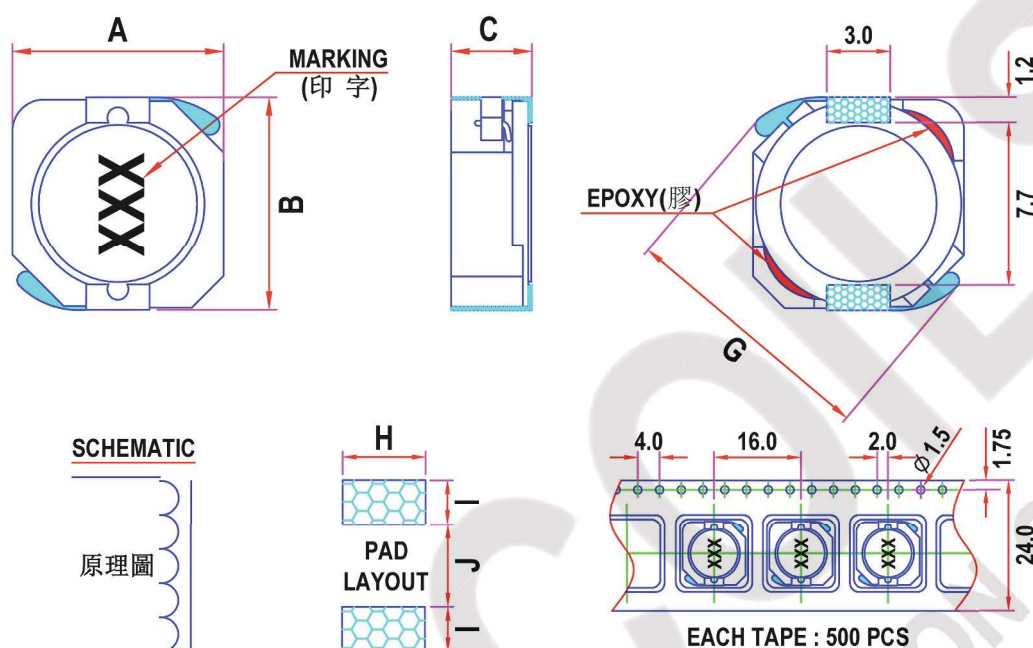
ADD: No 6 Industrial Park Nanlang Town Zhongshan Guangdong,P.R.China

### Revision And History :

|                 |                     |             |    |              |            |
|-----------------|---------------------|-------------|----|--------------|------------|
| <b>3L P/N :</b> | SMTDRH105RQ-100M-CH | <b>Rev.</b> | XA | <b>Date:</b> | 2021/11/25 |
|-----------------|---------------------|-------------|----|--------------|------------|

|           |       |               |              |
|-----------|-------|---------------|--------------|
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|-----------|-------|---------------|--------------|

# 1.Mechanical Dimension:



| Item | Spec.(mm) | Typ.(mm) | Item | Spec.(mm) | Typ.(mm) |
|------|-----------|----------|------|-----------|----------|
| A    | 10.3 MAX  | 10.03    | F    |           |          |
| B    | 10.5 MAX  | 10.14    | G    | 13.5 MAX  |          |
| C    | 5.1 MAX   | 4.78     | H    | 3.6 TYP   |          |
| D    |           |          | I    | 1.7 TYP   |          |
| E    |           |          | J    | 7.3 TYP   |          |

## Notes:

Marking : 100

Color/ Style/ Size : 黑色印字

- 1.Coplanarity is 0.15mm Max.
- 2.The product terminal electrode tin coating covers an area of >95%.(based on IEC 60068-2-58)
- 3.The appearance defect of magnetic core meets the IEC-60424. If the customer has special requirements, the customer's standard shall prevail.

|          |                     |      |    |       |            |
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## 2. Electrical Characteristics (at 25degC / RH 65% unless otherwise specified):

| Test Item | Specifications                       | Test conditions | Typ. | Test Instrument |
|-----------|--------------------------------------|-----------------|------|-----------------|
| L         | 10uH $\pm$ 20%                       | @100KHz 1V      |      | Agilent4284A    |
| L Load    | +4.4A: L drop 35% MAX                | @100KHz 1V      |      | Agilent42841A   |
| DCR       | 28m $\Omega$ MAX                     |                 |      | ChenHwa502      |
| I sat     | 4.4A MAX (5.6A Typ)                  | @100KHz 1V      |      | Agilent42841A   |
| I rms     | 3.5A MAX (4.4A Typ)                  |                 |      | Testo608-H2     |
| Ope.Temp. | -40 $^{\circ}$ C TO 125 $^{\circ}$ C |                 |      |                 |

### Notes :

- 1.Isat: The current when the inductance becomes 35% lower than its initial value
- 2.Irms: The current when temperature of coil increase up to max. (temperature increase of 40Deg. by self heating )
- 3:Rated Current:Smaller value of either Isat or Irms.
- 4.Self heating (temperature increase) occurs when the power is turned on so the tolerance should be sufficient for the set thermal design
- 5.Above definition are general standards for the designing of the inductor, The definition of specification shall prevail if there is any discrepancy with the definition of specification

|                 |                     |             |    |              |            |
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|                        |                                   |
|------------------------|-----------------------------------|
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|------------------------|-----------------------------------|

### 3. Material List:

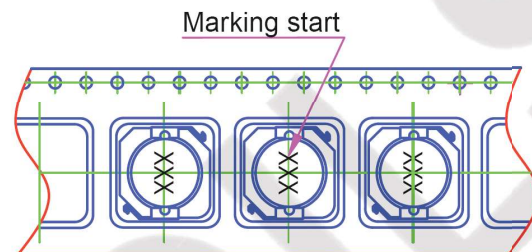
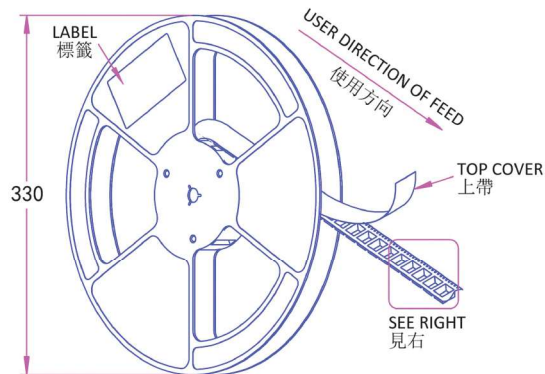
| Item  | Description (Or Equal) | Supplier (Or Equal) | UL No.& Temp. |
|-------|------------------------|---------------------|---------------|
| CORE  | Ferrite Ni-Zn          | MAXTOR              | N/A           |
| Wire  | Copper wire (Cu)       | ELEKTRISOLA         | E258243       |
| BASE  | Cu Ni Sn               | SHUOHUI             | N/A           |
| Sn    | Lea-Free solder        | THOUSAND ISLAND     | N/A           |
| Epoxy | 6020H                  | WELLS               | E229633       |
| INK   | T13 BLACK              | BAOLIJIE            | N/A           |

|                 |                     |             |    |              |            |
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#### 4. Packaging Specification:

##### Inside Packaging:



Each reel : 500 pcs;

##### Notes of inside packing :

- 1.TAPE TRAILER 160~200mm (起始空帶160~200mm);
- 2.TAPE LEADER 388~428mm (結尾空帶388~428mm);
- 3.包裝圖可能會使用同類品進行方法和要求的示範,可能會與實物存在偏差 !

##### Outside Packaging: .gif/.gif

Small carton: 1,000 pcs; Outer carton: 5,000 pcs; NW.: KG; GW.: KG

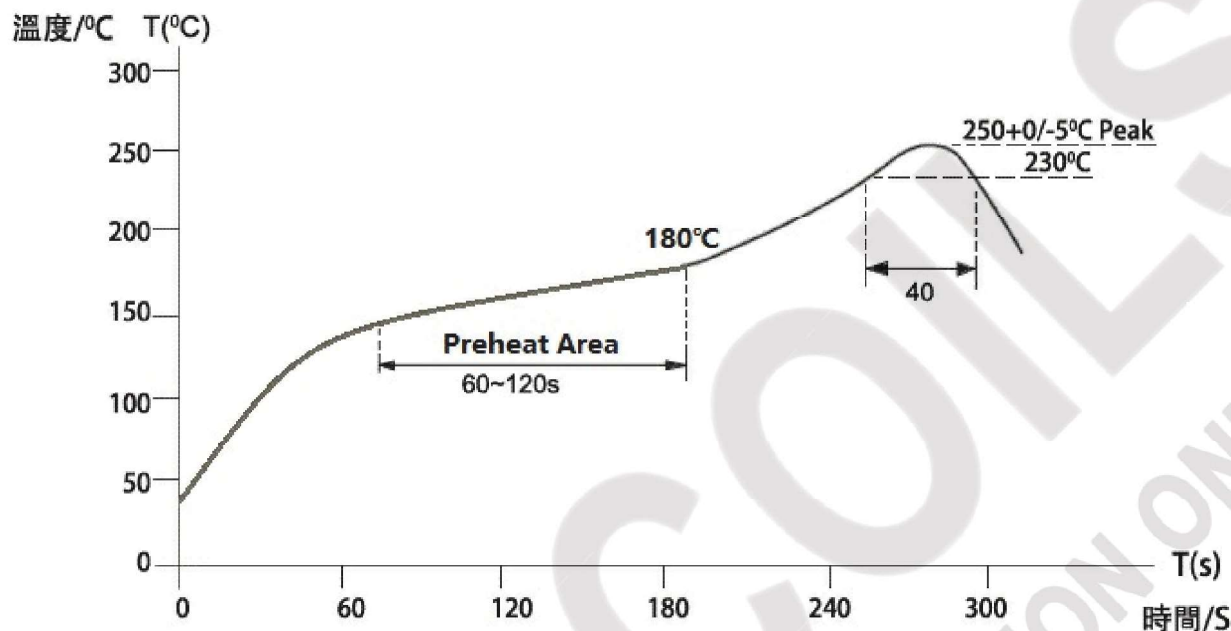
##### Notes :

- 1.In general, the printing direction of the product is not fixed, but the electrode direction is fixed, unless otherwise specified
- 2.The storage period is less than 12 months ,Be sure to follow the storage conditions(temperature:10-30 Deg. humidity:35 to 65% RH or less) if the storage period elapses the soldering of the fernal electrodes may deteriorate.
- 3.Taping ane reel Specification compliant the EIA -481.

|                 |                     |             |    |              |            |
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## Appendix 1: Lead-free the recommended reflow condition (SMT Type)

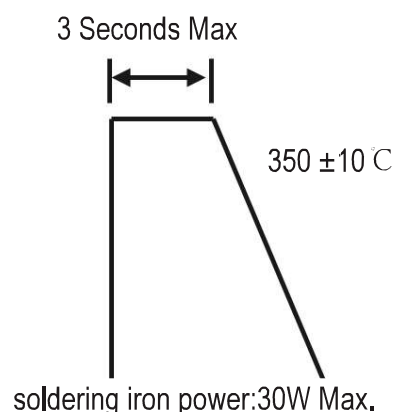


### Notes:

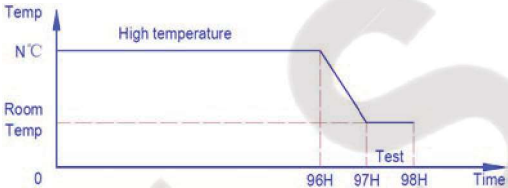
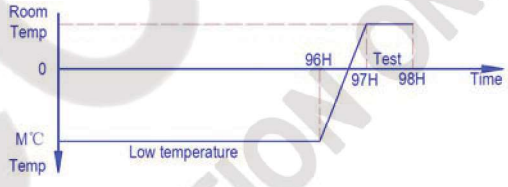
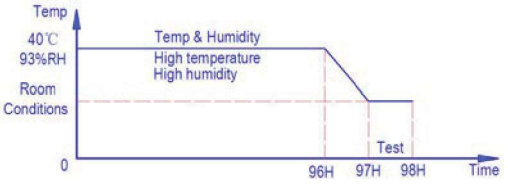
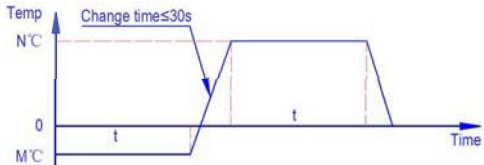
The recommended reflow conditions as graph, is set according to our soldering equipment, due to various manufacturers may have different reflow soldering equipments, products, process conditions, set methods and so on, when setting the reflow conditions, Please adjust and confirm according to users' environment/equipments, Number of reflow soldering : No more than 2 times

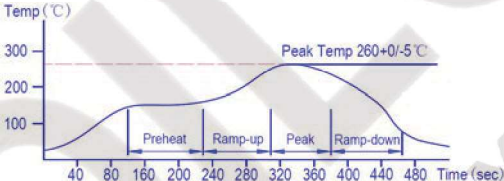
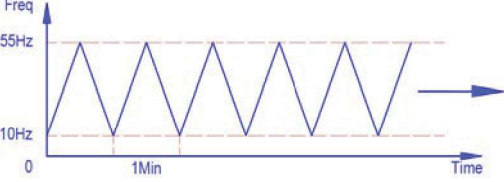
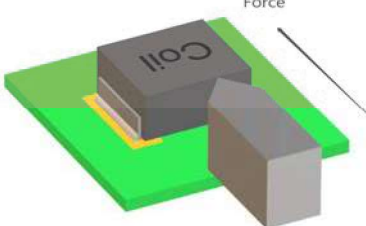
## Appendix 2: Soldering Iron (Rework)

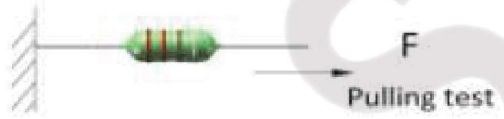
1. Use a soldering iron to solder inductors by hand, times does not exceed 350 degrees 3 times.
2. When soldering iron welding, please try to avoid contacting the inductor itself. (definitely do not contact the wire)
3. To solder inductors by soldering iron is not recommended.



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| Item (項目)                                                                                       | Required Characteristics (要求)                                                                                                                                                                                                                                                                                                                                                                                                   | Test Method / Condition (測試方法)                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|-------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p>High temperature Storage test</p> <p>Reference documents:<br/>GB/T 2423.2-2008 Method Bb</p> | <p>1. No significant defects in appearance.<br/>2. <math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)<br/>3. <math>\Delta Q/Q \leq 30\%</math> (Only SMD series)<br/>4. <math>\Delta DCR/DCR \leq 10\%</math></p>                                                                                                                                                                                     | <p>Temperature: <math>N \pm 2^\circ\text{C}</math> (N: Follow the product specification for the setting.)<br/>Time : 96<math>\pm</math>2 hours<br/>Place the samples for one hour at room temperature and test them within two hours</p>  <p>溫度: <math>N \pm 2^\circ\text{C}</math> (N:依據產品規格設定)<br/>時間: 96<math>\pm</math>2 小時<br/>樣品在室溫下放置1小時,不超2小時必須測試。</p>                           |
| <p>Low temperature Storage test</p> <p>Reference documents:<br/>GB/T 2423.1-2008 Method Ab</p>  | <p>1. No significant defects in appearance.<br/>2. <math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)<br/>3. <math>\Delta Q/Q \leq 30\%</math> (Only SMD series)<br/>4. <math>\Delta DCR/DCR \leq 10\%</math></p>                                                                                                                                                                                     | <p>Temperature: <math>M \pm 2^\circ\text{C}</math> (M: Follow the product specification for the setting.)<br/>Time : 96<math>\pm</math>2 hours<br/>Place the samples for one hour at room temperature and test them within two hours</p>  <p>溫度: <math>M \pm 2^\circ\text{C}</math> (M:依據產品規格設定)<br/>時間: 96<math>\pm</math>2 小時<br/>樣品在室溫下放置1小時,不超2小時必須測試。</p>                          |
| <p>Humidity test</p> <p>Reference documents:<br/>GB/T 2423.3-2016</p>                           | <p>1.No significant defects in appearance.<br/>2. <math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)<br/>3. <math>\Delta Q/Q \leq 30\%</math> (SMD series only)<br/>4. <math>\Delta DCR/DCR \leq 10\%</math></p>                                                                                                                                                                                      | <p>Temperature: <math>40 \pm 2^\circ\text{C}</math> , Humidity: <math>93 \pm 3\% \text{RH}</math><br/>Time : 96<math>\pm</math>2 hours<br/>Place the samples for one hour at room temperature and test them within two hours</p>  <p>溫度: <math>40 \pm 2^\circ\text{C}</math> , 溼度: <math>93 \pm 3\% \text{RH}</math><br/>時間 : 96<math>\pm</math>2 hours<br/>樣品在室溫下放置1小時,不超2小時必須測試。</p> |
| <p>Thermal shock test</p> <p>Reference documents:<br/>GB/T 2423.22-2012 Method Na</p>           | <p>1. No significant defects in appearance.<br/>2. <math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)<br/>3. <math>\Delta Q/Q \leq 30\%</math> (SMD series only)<br/>4. <math>\Delta DCR/DCR \leq 10\%</math></p> <p>T: 15Min if weight <math>\leq 28\text{g}</math>    M: low temp. setting<br/>T: 30Min if <math>28\text{g} \leq \text{weight} \leq 136\text{g}</math>    N: high temp. setting</p> | <p>Start at <math>M^\circ\text{C}</math> for T time, rush to <math>N^\circ\text{C}</math> for T time as one cycle, go through 20 cycles.</p>  <p>從<math>M^\circ\text{C}</math>作用T分鐘,然後溫度衝擊到<math>N^\circ\text{C}</math>作用T分鐘,作為一個循環,共作用20次。</p>                                                                                                                                        |
| <p>冷熱衝擊試驗</p>                                                                                   | <p>1.無明顯的外觀缺陷<br/>2.感值變化小於10% (錳鋅材質感值變化不超過30%)<br/>3.品質因數變化小於30% (僅限SMD系列)<br/>4.直流電阻變化小於10%</p>                                                                                                                                                                                                                                                                                                                                |                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |

| Item (項目)                                                                                                              | Required Characteristics (要求)                                                                                                                                                                                                                                                                                                                                                                                                                        | Test Method / Condition (測試方法)                                                                                                                                                                                                                                                                                                                                                 |
|------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p>Solderability test</p> <p>Reference documents:<br/>GB/T 2423.28-2005 Method Ta</p> <p>可焊性測試</p>                     | <p>Terminals must have 95% minimum solder coverage</p> <p>端子必須有95%以上著錫</p>                                                                                                                                                                                                                                                                                                                                                                           | <p>1.Dip the terminals in the flux then in the solder pot at 245±5℃ for 5 seconds.</p> <p>2.Solder: lead free</p> <p>3.Flux: rosin flux</p> <p>1.端子浸入助焊劑, 然後浸入245±5℃ 錫爐中5秒</p> <p>2.焊料: 無鉛焊料</p> <p>3.助焊劑: 松香助焊劑</p>                                                                                                                                                           |
| <p>Heat endurance of Reflow soldering</p> <p>Reference documents:<br/>GJB 360B-2009 Method 210</p> <p>耐焊接熱試驗 (SMT)</p> | <p>1.No significant defects in appearance.</p> <p>2.<math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)</p> <p>3.<math>\Delta Q/Q \leq 30\%</math> (SMD series only)</p> <p>4.<math>\Delta DCR/DCR \leq 10\%</math></p> <p>1.無明顯的外觀缺陷</p> <p>2.感值變化不超過10% (錳鋅材質感值變化不超過30%)</p> <p>3.品質因數變化不超過30% (僅限SMD系列)</p> <p>4.直流電阻變化不超過10%</p>                                                                                        | <p>1.Refer to the above reflow curve and go through the reflow for twice.</p> <p>2.The peak temperature : 260+0/-5℃</p> <p>3.The reflow test conditions are based on the testing instruments available in 3L</p>  <p>1.參照上圖回流焊曲線過2次</p> <p>2.峰值溫度為: 260+0/-5℃</p> <p>3.迴流焊溫度條件是根據我司設備制定的</p> |
| <p>Heat endurance of Reflow soldering</p> <p>Reference documents:<br/>GJB 360B-2009 Method 210</p> <p>耐焊接熱試驗 (DIP)</p> | <p>1.No significant defects in appearance.</p> <p>2.<math>\Delta L/L \leq 10\%</math> (Mn-Zn: <math>\Delta L/L \leq 30\%</math>)</p> <p>3.<math>\Delta Q/Q \leq 30\%</math> (SMD series only)</p> <p>4.<math>\Delta DCR/DCR \leq 10\%</math></p> <p>1.無明顯的外觀缺陷</p> <p>2.感值變化不超過10% (錳鋅材質感值變化不超過30%)</p> <p>3.品質因數變化不超過30% (僅限SMD系列)</p> <p>4.直流電阻變化不超過10%</p>                                                                                        | <p>1. DIP in solder pot at 260+0/-5℃ for 10 second.</p> <p>2. Solder: lead free</p> <p>1.端子浸入260+0/-5℃ 錫爐中10秒;</p> <p>2.焊料: 無鉛焊料</p>                                                                                                                                                                                                                                           |
| <p>Vibration test</p> <p>Reference documents:<br/>GB/T 2423.10-2019</p> <p>振動試驗 (正弦)</p>                               | <p>1.No significant defects in appearance.</p> <p>2.No short and no open.</p> <p>1.無明顯的外觀缺陷</p> <p>2.無短路開路異常</p>                                                                                                                                                                                                                                                                                                                                     | <p>Apply frequency 10~55~10Hz and amplitude 1.5mm, 1 min/cycle in X、Y and Z direction for 2 hours each, (total 6 hours)</p>  <p>用10~55~10Hz 振動頻率, 振幅1.5mm, 振動週期為1min/cycle, 沿X,Y,Z方向各振動2小時.(共6小時)</p>                                                                                      |
| <p>Terminal strength(SMT)</p> <p>Reference documents:<br/>GB/T 2423.60-2008</p> <p>端子強度 (SMT)</p>                      | <p>1. HPI / SMD(V) / SMB / SMI / SMW series:<br/>Applied force:5N Duration: 10sec</p> <p>2.Other SMT series besides the above series:<br/>Applied force:10N Duration: 10sec</p> <p>3.Solder paste thickness:0.12mm</p> <p>4.Meet the above requirements without any loose terminal.</p> <p>1. HPI / SMD(V) / SMB / SMI / SMW 系列:<br/>施加力:5N 持續時間:10秒</p> <p>2.除上述系列以外的其他SMT系列:<br/>施加力:10N 持續時間:10秒</p> <p>3.錫膏厚度:0.12毫米</p> <p>4.端子不發生鬆脫並滿足上述要求</p> | <p>Solder the test samples to the PCB through 245 °C reflow, apply a standard force on the side of the test samples for 10 seconds.</p>  <p>測試樣品過245℃的迴流焊上PCB板, 施加一個力到測試器件的側面, 這個力應持續10秒。</p>                                                                                              |

| Physical characteristic tests (物理特性試驗) | Item (項目)                                   | Required Characteristics (要求)                                                                                                                                                                                                                                                                                                                                                                              | Test Method / Condition (測試方法)                                                                                                                                                                |
|----------------------------------------|---------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                        | Terminal strength(DIP)                      | 1.Terminal diameter(d) mm $0.35 < d \leq 0.50$<br>Applied force:5N Duration: 10sec<br>2.Terminal diameter(d) mm $0.50 < d \leq 0.80$<br>Applied force:10N Duration: 10sec<br>3.Terminal diameter(d) mm $0.80 < d \leq 1.25$<br>Applied force:20N Duration: 10sec<br>4.Terminal diameter(d) mm $d > 1.25$<br>Applied force:40N Duration: 10sec<br>5.Meet the above requirements without any loose terminal. | Pull Force:the force shall be applied gradually to the terminal and then maintained for 10 seconds.<br><br> |
|                                        | Reference documents:<br>GB/T 2423.60-2008   |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                               |
|                                        | 端子強度 (DIP)                                  | 1. 引出端直徑(d) mm $0.35 < d \leq 0.50$<br>施加力:5N 持續時間:10秒<br>2. 引出端直徑(d) mm $0.50 < d \leq 0.80$<br>施加力:10N 持續時間:10秒<br>3. 引出端直徑(d) mm $0.80 < d \leq 1.25$<br>施加力:20N 持續時間:10秒<br>4. 引出端直徑(d) mm $d > 1.25$<br>施加力:40N 持續時間:10秒<br>5. 端子不發生鬆脫並滿足上述要求                                                                                                                                                         | 拉力:拉力逐漸到最大值維持10秒.                                                                                                                                                                             |
|                                        | Drop test                                   | 1.No case deformation or change in appearance.<br>2.No short and no open.                                                                                                                                                                                                                                                                                                                                  | Drop the packaged products from 1m high in 1 angle, 3 ridges and 6 surfaces, twice in each direction.                                                                                         |
|                                        | Reference documents:<br>GB/T 2423.7-2018    |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                               |
|                                        | 落下試驗                                        | 1.無明顯的外觀缺陷<br>2.無短路開路異常                                                                                                                                                                                                                                                                                                                                                                                    | 將產品包裝後從1米高度自然落下至試驗板上<br>1角3棱6面各跌落兩次                                                                                                                                                           |
|                                        | Resistance to solvent test                  | No damage in appearance or marking                                                                                                                                                                                                                                                                                                                                                                         | Dip parts into IPA solvent for $5 \pm 0.5$ min, dry them at room temp for 5 min, then brush them for 10 times.                                                                                |
|                                        | Reference documents:<br>GB / T 2423.30-2013 |                                                                                                                                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                               |
|                                        | 耐溶劑性試驗                                      | 無外觀破損及標記破損                                                                                                                                                                                                                                                                                                                                                                                                 | 在IPA溶液中浸泡 $5 \pm 0.5$ 分鐘，室溫下乾燥5分鐘，然後擦拭10次                                                                                                                                                     |



# Cautions and Warnings

## 提醒及警告



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### Scope of 3L products:

1. 3L components are manufactured and promoted for applying in general electronics devices such as audio-video equipment, home electric appliance, office automation equipment, communication equipment, power module, LED lighting, measurement hardware, machine accessory, etc.  
(本公司的產品使用于影音,家電,辦公自動化,通訊,電源模塊,LED照明,測量設備,機械工具等一般電子設備中.)
2. If 3L product will be applied in area like automotive product, medical equipment, military and aerospace except general electronic device, please keep 3L sales informed in advance. 3L shall not be held liable for any malfunction or breakdown caused by using product in the condition which is inconsistent with that recommended by 3L.  
(當本公司產品使用在一般電子設備以外的場合,如:車載,醫療設備,軍用,航空航天等,請務必聯繫本公司營業部門,如超出本公司產品推薦的使用條件而引起的機器故障時,本公司不承擔相關責任.)
3. If there is problem occurring when using product or information on 3L's catalogue, which may affect industrial property or any other rights of 3L Group (or a third party), 3L Group shall not be held liable in such situation, nor grant any license to the offending party.  
(在使用本公司的目錄上的產品或信息時,如發生涉及到本公司或第三者的產業財產權(工業所有權)以及其他權利的相關問題,本公司恕不負責,亦不授權給侵害方.)
4. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application.  
(在此處指明的一些產品包含有關我們的產品在某些應用領域的適用性陳述.這些陳述是基於我們對有關應用領域中經常放在的產品上的典型要求了解.然而,我們明確指出,這些聲明不能被視為對某些特殊的客戶運用適合的聲明.)
5. Generally, 3L might not be familiar with either customer's specific application or actual requests as customer does. As a result, customer shall be responsible for checking and confirming whether 3L product with the performance described in the product specification is suitable for using in customer's particular application or not.  
(通常情況下,3L不熟悉特定客戶的應用,也不熟悉客戶本身需求,由於這些原因,客戶始終有責任檢查並確定具有產品規格中描述的屬性的3L產品是否適合在特定客戶的應用.)
6. We also have to point out that in individual cases, any trouble or failure of electronic components happens during their long span cannot not be completely cleared even if someone operates according to instruction with existing technology.  
(在個案中,我們也要指出,在現有技術中,即使按照規定進行操作,電子元件在其通常使用壽命結束之前發生故障也不能完全排除的.)
7. Please pay attention to the storage conditions that temperature: below 35°C and humidity: 35-65% RH . If product is preserved for more than 1 year, the solderability of their terminals may be deteriorated.  
(產品在規定的溫度和濕度條件下保存:溫度: 35 C 以下,濕度: 35-65% RH , 如果保存期超過1年,端子的可焊性可能會變差.)
8. The aforementioned items do not apply to individual agreements and the foregoing customer-specific products.  
(上述內容不適用於個人協議和客戶上述提到的特定產品.)

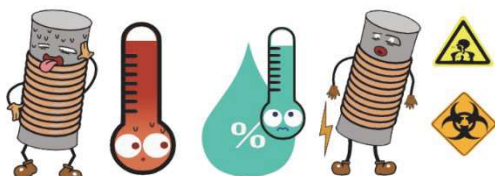
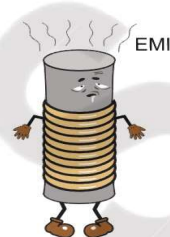
*Please read cautions and warnings, important notes at the end of this document.*

If you have any question, please contact 3L. 如有任何問題請聯繫3L.



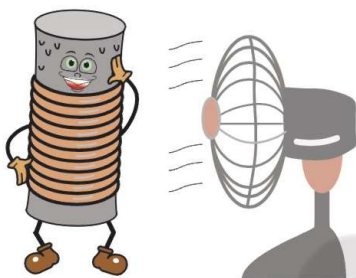
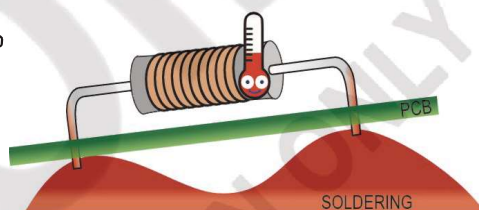
### General instruction for parts usage:

1. Please pay more attention to the installation position of the non-magnetic shield type coil when you design the printed circuit board to prevent malfunction caused by magnetic interference.  
(在設計PCB時, 請考慮非磁屏蔽元器件的安裝位置, 避免磁干擾引起的故障.)



2. Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.  
(請不要將產品保存在高溫、高濕、有灰塵、腐蝕性氣體等不適合環境中.)

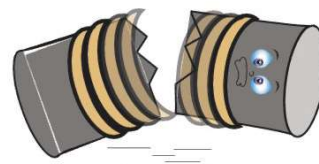
3. The soldering conditions should also be observed. Temperature mentioned refers to the temperature of wave soldering for PIN or terminals but not the temperature of product itself.  
(應留意焊錫條件, 說明中如有提及到焊錫溫度, 是指PIN或端子浸入波峰焊的溫度, 而不是指產品本体.)



4. Please take the thermal design into consideration when choosing appropriate product, because the coil generates heat when electric current is applied.  
(工作時電流通過繞組會產生一定的熱量, 在選用時請做散熱設計之考量.)

5. Please don't use products in a place with dewing. Please be careful when products is applied in a sealed condition since dewing would happen due to temperature change.  
(請避免在結露的環境下使用, 在密閉環境中, 由於溫度的變化會導致結露, 使用時請注意.)

6. Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.  
(請小心輕拿輕放, 避免由於產品的跌落或取出不當而導致的損壞.)

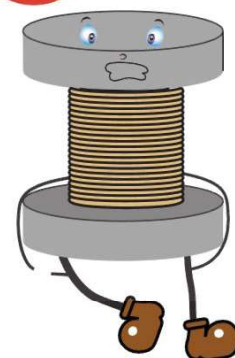


7. Don't touch electrodes directly with bare hands since oil secretions may do harm to solderability.  
(手上有油脂可能導致可焊性下降. 請避免手直接接觸端子.)



8. Don't bend the terminals with excessive stress in case of any wire fracture.  
(端子過度彎曲會導致斷線, 請不要過度彎曲端子.)

9. Please ensure that all terminals and case lugs are completely fixed onto PCB by soldering, and avoid placing coils near the edge of the PCB.  
(請確保所有端子和膠殼足完全焊接到印刷電路板上, 盡量避免產品放在印刷電路板邊緣.)



10. Don't rinse coils by yourself and please contact 3L if necessary.  
(不要清洗產品, 如需要清洗時請聯繫我司.)

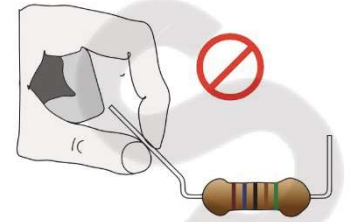
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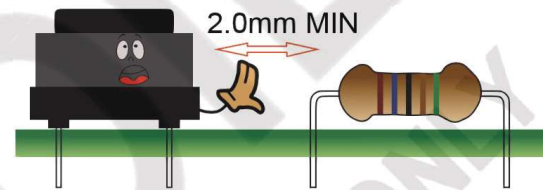
11. Since our SMD coils are designed for automatic mounting, please be careful when soldering manually. Please don't touch any exposed winding part and coil should not be used guiding by electrode in automatic mounting.

(由於表面貼裝件都是以自動安裝為基準設計,手動焊錫時請注意.產品自動安裝,請避免接觸卷線露出的部分.另外,不能將端子作為導向使用.)



12. Our specification specifies the quality of the component as a single unit. Please ensure the component is thoroughly evaluated in your application circuit.  
(本公司的規格書中只規定了產品的品質,在貴司使用中,請務必確認安裝在貴公司產品的狀態.)

13. When using our high voltage inverter transformers, please place it 2mm away from other electric conductors.  
(對於產品高壓的逆變變壓器,在使用設計時要注意其他導體要離逆變器2mm以上.)



14. The following points must be paid attention to if the components are potted or glued to stick in customer applications:  
(在客戶使用時,如果產品被灌封或膠固定,必須注意:)

- Many potting materials shrink as they harden. Therefore, they exert a pressure on the plastic housing or core, which may have a deleterious effect on electrical performance. In extreme cases, it would damage the mechanical performance of core or plastic housing.  
(大部分灌封材料在硬化時都會收縮,因此對塑膠骨架或磁芯施加壓應力,這種應力作用可以給電氣特性帶來負面影響,極端情況下可能損壞磁芯或塑膠骨架的機械性能.)
- It is necessary to check whether the potting material used would lead to undesirable performance or break down of insulating layer of enameled wire, plastic bobbin or glue.  
(必須檢查使用灌封材料是否會導致漆包線的絕緣層.塑膠骨架或膠水的性能降低甚至損壞.)
- The potting material can affect the high-frequency behavior of components.  
(灌封材料的影響可以改變磁性元器件的高頻特性.)
- Ferrites are sensitive to direct shock, which might hurt or even break the core.  
(鐵氧體對直接衝擊是很敏感的,衝擊可能導致磁性材料損傷甚至破碎.)
- For non-Alloy or non-coated molded inductors, its surface might become rusted if it was left in the humid environment. However, its electrical performance would not be affected.  
(對於非合金或非涂层模壓產品,如果將產品長期放置在潮濕的環境中,產品的表面可能會生鏽,但不會影響產品的特性.)
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by customer.  
(即使是客戶的特殊產品,決定性的驗證組件的電路也只能通過客戶執行.)

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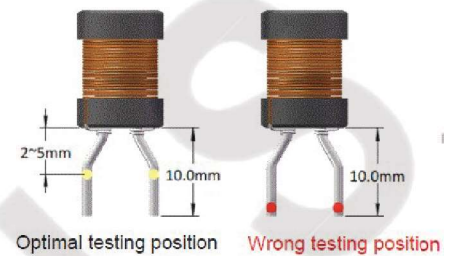


Note 1. The general testing condition is Temperature: 25 +/- 5°C (Room temperature) and humidity: 35-65% RH, which is applied to all products except specific product.

(注意 1. 除非特別指定,所有產品測試條件為:溫度: 25+/-5°C[室溫],濕度:35-65%RH.)

Note 2. For DIP type products, when the pin length is more than 5mm, the test position should be at 2-5mm away from the bottom of the product; For SMT type products, it is suggested to ensure better contact between the products and the tooling, shown as the right picture:

(注意 2. DIP 產品腳長超過 5mm 時,測試位置應選取在產品底部 2-5mm 處;對 SMT 產品,產品的測試端子與夾具接觸良好,如右圖:)



### 1. Inductance Test 電感測試

There could be measurement deviations with different instruments due to different test principles / internal resistance. Open and Short compensation should be performed before testing. Select the measurement fixture or testing wire that goes with the original instrument.  
(不同儀器會因測試內阻及方法的不同而導致測試偏差,測量前需要進行歸零補償,測量時請選取儀器自帶的治具及測試線.)

### 2. Leakage Inductance Test 漏感測試

There could be measurement deviations with different instruments due to different test principles / internal resistance. Open and Short compensation should be performed before testing. Select the measurement fixture or testing wire that goes with the original instrument.  
(不同儀器會因測試內阻及方法的不同而導致測試偏差,測量前需要進行歸零補償,測量時請選取儀器自帶的治具及測試線.)

### 3. DCR Test 直流電阻測試

Shorten the testing wire as much as possible to ensure better contact between the products and the tooling; there would be deviations for the DCR if the testing tooling contact surface is worn out or if the testing method is not correct, especially for low DCR products.  
(盡量減短測試線的長度,保證產品與治具良好接觸,當測試夾具接觸面磨損或測量方法不正確時,會導致 DCR 值的偏差,特別是當 DCR 值較小時.)

### 4. Rated Current, Saturation Current, Temperature Rise Current 額定電流, 飽和電流, 溫升電流

The saturation current is decided according to the initial inductance drop amount; the rated current is generally taken by the smaller value between the saturation current and temperature rise current.  
(飽和電流依初始電感下降變化量來選取;額定電流一般選取飽和電流和溫升電流兩者之間取較小值.)

### 5. Q Factor / SRF / Z Test 品質因數 / SRF / 阻抗測試

Shorten the pin length as much as possible to ensure better contact between the products and the tooling; there can be deviation if the testing tooling contact surface is worn out or if the testing method is not correct.  
(盡量減短引線的長度,保證產品與治具良好的接觸,當測試夾具接觸面磨損或測量方法不正確時,會導致測試值的偏差.)

### 6. Turns Ratio and Phase Test 圈比及相位測試

There would be deviations for turn counts ratio when there is magnetic leakage or air gap in the core center, please pay attention to the differences during testing. If the air gap is too large, then use the planar cores for confirmation; be careful to choose the foot position when testing the polarity.  
(漏磁及產品耦合不良等原因會導致圈比測試偏差,請在測試中注意區分;當產品的氣隙過大時,請使用平面磁芯確認,相位測試注意腳位選取.)

### 7. Hi-Pot Test 高壓測試

Choose AC or DC accordingly during Hi-pot testing since they are different. If the humidity is too high or there is pollution on the surface, the Hi-pot test might fail. Please avoid testing in high humidity condition and keep the tooling and products clean. The Hi-pot test is destructive test and repeat testing should be avoided.  
(AC 與 DC 的耐壓不同,請在測試時選擇相應的設置,濕度過高及表面受污染則可能會導致耐壓不良,請避免在高濕下測試並保持治具及測試產品乾淨.耐壓測試為破壞性測試,請避免重複測試.)

### 8. IWT Test 層間短路測試

Carefully choose the voltage and standard sample for the testing, IWT test is destructive testing and repeat testing should be avoided.  
(注意電壓和標準樣品的選取,測試為破壞性測試,避免重複測試.)

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